



Integrated Device Technology, Inc.  
2975 Stender Way, Santa Clara, CA - 95054

## PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: **L-0505-05** DATE: 6/3/2005  
Product Affected: IDTCSPUA877 & IDT74SSTUA32866  
All package options

Date Effective: June 3, 2005

### MEANS OF DISTINGUISHING CHANGED DEVICES:

- ☐ Product Mark  
☐ Back Mark  
☒ Date Code  
☐ Other

Contact: Bimla Paul  
Title: Quality Assurance Manager  
Phone #: (408)-654-6419  
Fax #: (408)-492-8362  
E-mail: bimla.paul@idt.com

Attachment: ☐ Yes ☒ No

Samples: N/A

### DESCRIPTION AND PURPOSE OF CHANGE:

- ☐ Die Technology  
☐ Wafer Fabrication Process  
☐ Assembly Process  
☐ Equipment  
☐ Material  
☐ Testing  
☐ Manufacturing Site  
☒ Data Sheet  
☐ Other
- $V_{DDQ}$  max and  $V_{OL}$  &  $V_{OH}$   $V_{DDQ}$  max change from 2.0V to 1.9V  
on IDTCSPUA877 & IDT74SSTUA32866 (all package options)  
to comply with JEDEC specification.

### RELIABILITY/QUALIFICATION SUMMARY:

There is no change in product quality and reliability.

### CUSTOMER ACKNOWLEDGMENT OF RECEIPT:

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.

IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: \_\_\_\_\_

☐ *Approval for shipments prior to effective date.*

Name/Date: \_\_\_\_\_

E-Mail Address: \_\_\_\_\_

Title: \_\_\_\_\_

Phone# /Fax# : \_\_\_\_\_

### CUSTOMER COMMENTS:

### IDT ACKNOWLEDGMENT OF RECEIPT:

RECD. BY: \_\_\_\_\_

DATE: \_\_\_\_\_